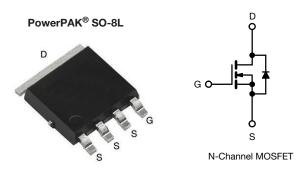
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	65	50		
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.208		
Q _g max. (nC)	2	3		
Q _{gs} (nC)	2	1		
Q _{gd} (nC)	6			
Configuration	Sin	gle		

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lood (Db) free and belogen free	SiHJ240N60E-T1-GE3
Lead (Pb)-free and halogen-free	SiHJ240N60E-T2-GE3

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unless	s otherwis	e noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current ($T_1 = 150 \ ^{\circ}C$)	V _{GS} at 10 V	$C_{\rm C} = 25 ^{\circ}{\rm C}$ $C_{\rm C} = 100 ^{\circ}{\rm C}$	1	12	
Continuous drain current $(1) = 150^{\circ}$ C)	V _{GS} at 10 V T ₀	_C = 100 °C	I _D	7	А
Pulsed drain current ^a			I _{DM}	30	
Linear derating factor				0.63	W/°C
Single pulse avalanche energy ^b			E _{AS}	81	mJ
Maximum power dissipation			PD	89	W
Operating junction and storage temperature ran	nge		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T,	ј = 125 °C	dv/dt	100	V/ns
Reverse diode dv/dt ^c	<u>.</u>		av/dl	28	v/ns

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2.4 A
- c. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

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SiHJ240N60E

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	52		65			°C/W	
Maximum junction-to-case (drain)	R _{thJC}	1.0		1.4			C/W	
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static					•	•		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
Onto norma la clusica		,	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
		V _{DS} =	: 600 V, V _G	_S = 0 V	-	-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	', V _{GS} = 0 V	∕, T _J = 125 °C	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _c	₀ = 5.5 A	-	0.208	0.240	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	= 20 V, I _D =	= 5.5 A	-	4	-	S
Dynamic	•	•			•	•		.
Input capacitance	C _{iss}		V _{GS} = 0 V		-	783	-	
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz $V_{DS} = 0 V to 480 V, V_{GS} = 0 V$		-	50	-	pF	
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}			-	32	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	187	-		
Total gate charge	Qg				-	15	23	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 5.5 \text{ A}, V_{DS} = 480 \text{ V}$		-	4	-	nC	
Gate-drain charge	Q _{gd}				-	6	-	1
Turn-on delay time	t _{d(on)}		•		-	15	30	
Rise time	t _r	V _{DD} =	480 V, I _D =	= 5.5 A,	-	14	28	ns
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R _g =	= 9.1 Ω	-	26	52	
Fall time	t _f	-			-	14	28	1
Gate input resistance	R _g	f = 1 MHz, open drain		0.8	1.5	3.0	Ω	
Drain-Source Body Diode Characteristi	cs	•			•	•	•	
Continuous source-drain diode current	١ _S	MOSFET symbol showing the		-	-	12		
Pulsed diode forward current	I _{SM}		p - n junction diode		-	-	30	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 5.5 A	A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	209	418	ns
Reverse recovery charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 5.5 A, di/dt = 100 A/μs, V _B = 25 V		-	2.1	4.2	μC	
Reverse recovery current	I _{RRM}		100 Av µ3, N	K - 20 V	-	18	-	Α

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

2

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

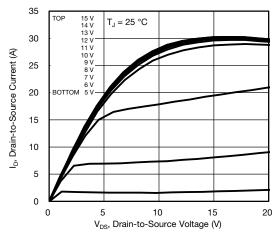
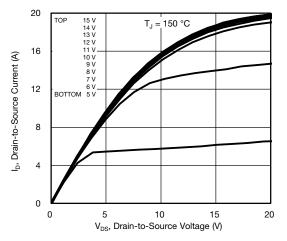


Fig. 1 - Typical Output Characteristics





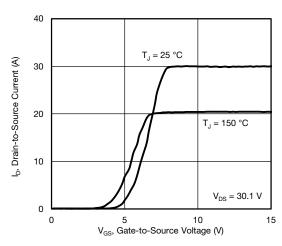


Fig. 3 - Typical Transfer Characteristics

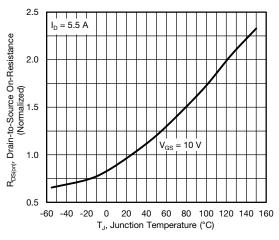


Fig. 4 - Normalized On-Resistance vs. Temperature

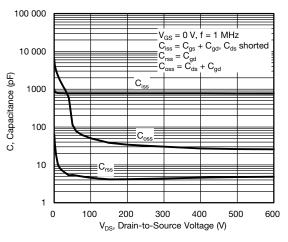


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

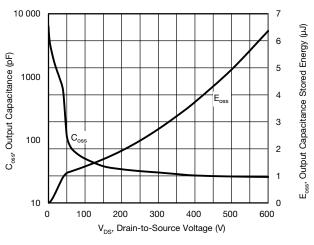


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S20-0348-Rev. C, 11-May-2020

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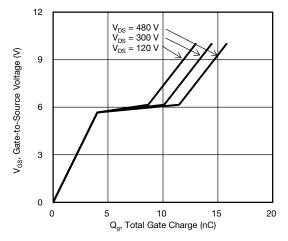


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

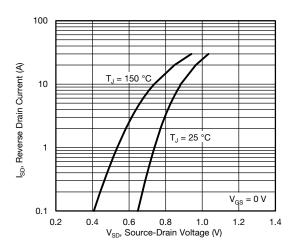


Fig. 8 - Typical Source-Drain Diode Forward Voltage

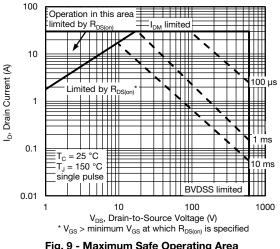


Fig. 9 - Maximum Safe Operating Area

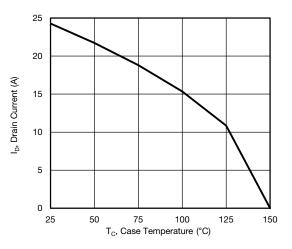


Fig. 10 - Maximum Drain Current vs. Case Temperature

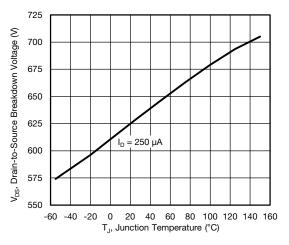


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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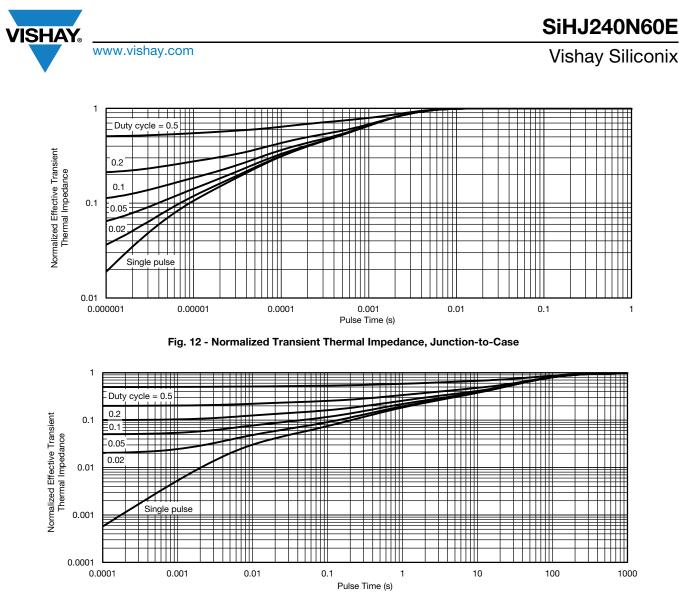


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

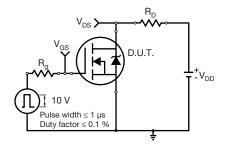


Fig. 14 - Switching Time Test Circuit

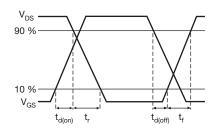


Fig. 15 - Switching Time Waveforms



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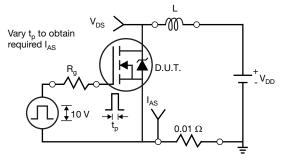


Fig. 16 - Unclamped Inductive Test Circuit

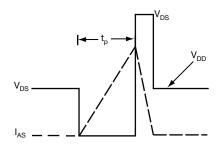


Fig. 17 - Unclamped Inductive Waveforms

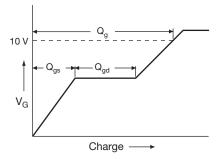


Fig. 18 - Basic Gate Charge Waveform

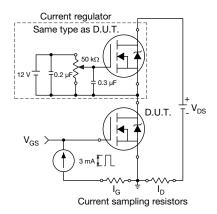


Fig. 19 - Gate Charge Test Circuit

6

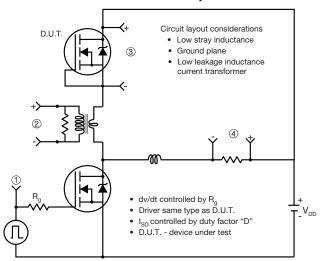
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Peak Diode Recovery dv/dt Test Circuit



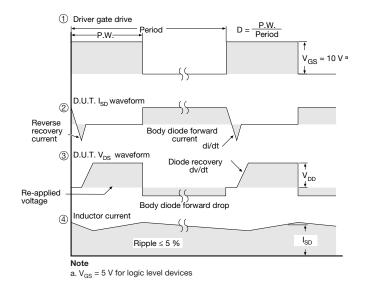


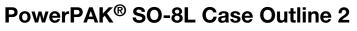
Fig. 20 - For N-Channel

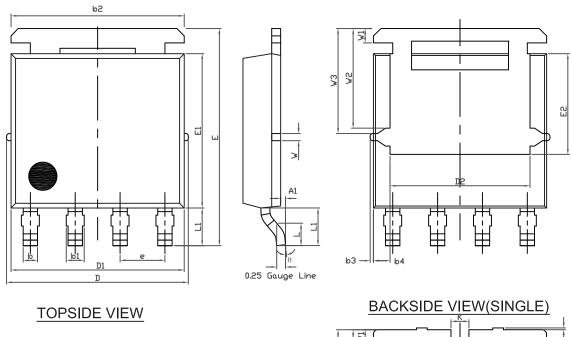
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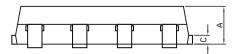
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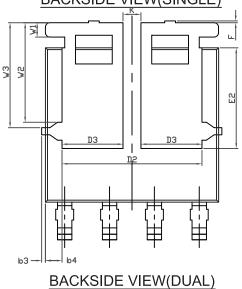


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Package Information



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		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN. NOM.		MAX	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	•		0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC	•	0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К		0.51			0.020		
W		0.23			0.009		
W1	0.41			0.016			
W2	2.82			0.111			
W3		2.96			0.117		
q	0°	-	10°	0°	-	10°	

Note

• Millimeters will gover



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RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



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